

100 V, P-channel Trench MOSFET

25 August 2020

**Product data sheet** 

#### 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

#### 2. Features and benefits

- Extended temperature range T<sub>i</sub> = 175 °C
- Trench MOSFET technology
- Very fast switching

#### 3. Applications

- Relay driver
- High-speed line driver
- High-side load switch
- Switching circuits

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-100	V
V <sub>GS</sub>	gate-source voltage			-25	-	25	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C	[1]	-	-	-1.2	А
Static chara	acteristics					·	
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -1.2 A; T <sub>j</sub> = 25 °C		-	280	365	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	3	D
2	S	source		
3	D	drain		G ( )
			1 2 SOT23	017aaa094

## 6. Ordering information

#### Table 3. Ordering information

Type number	ype number Package				
	Name	Description	Version		
PMV240SP		plastic, surface-mounted package; 3 terminals; 1.9 mm pitch; 2.9 mm x 1.3 mm x 1 mm body	SOT23		

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code[1]
PMV240SP	VY%

[1] % = placeholder for manufacturing site code

#### 8. Limiting values

#### Table 5. Limiting values

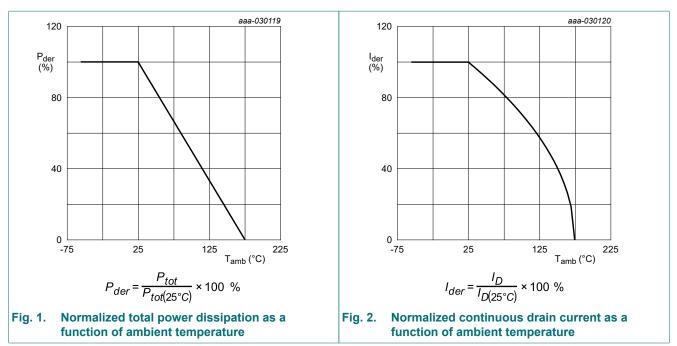
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-100	V
V <sub>GS</sub>	gate-source voltage			-25	25	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 25 °C	[1]	-	-1.2	А
		V <sub>GS</sub> = -10 V; T <sub>amb</sub> = 100 °C	[1]	-	-0.8	A
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-5	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	710	mW
			[1]	-	1.3	W
		T <sub>sp</sub> = 25 °C		-	8.3	W
Tj	junction temperature			-55	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C
Source-drain	n diode			I		
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-1.4	А
ESD maximu	um rating					
V <sub>ESD</sub>	electrostatic discharge voltage	НВМ	[3]	-	400	V
Avalanche r	uggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	T <sub>j(init)</sub> = 25 °C; I <sub>D</sub> = -0.5 A; DUT in avalanche (unclamped)		-	24	mJ

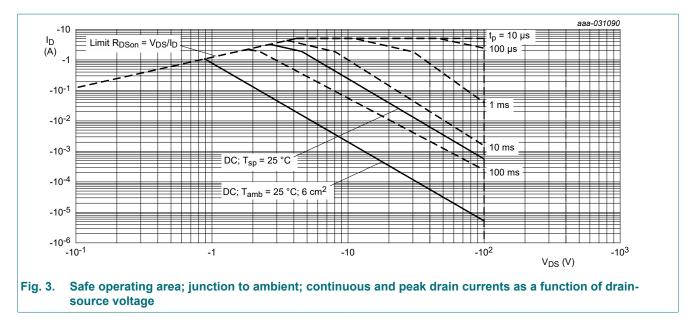
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Measured between all pins.



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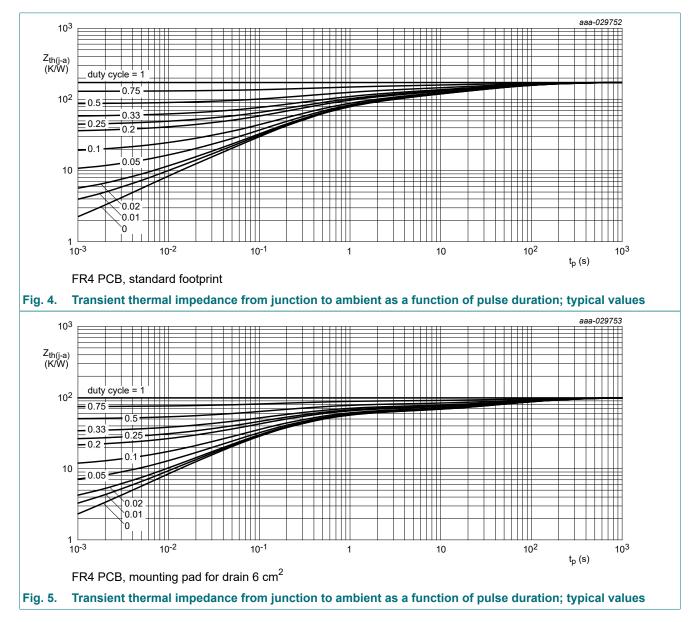
PMV240SP

### 9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ui()-a)		resistance from in free air	[1]	-	175	210	K/W
	junction to ambient		[2]	-	95	115	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	13	18	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

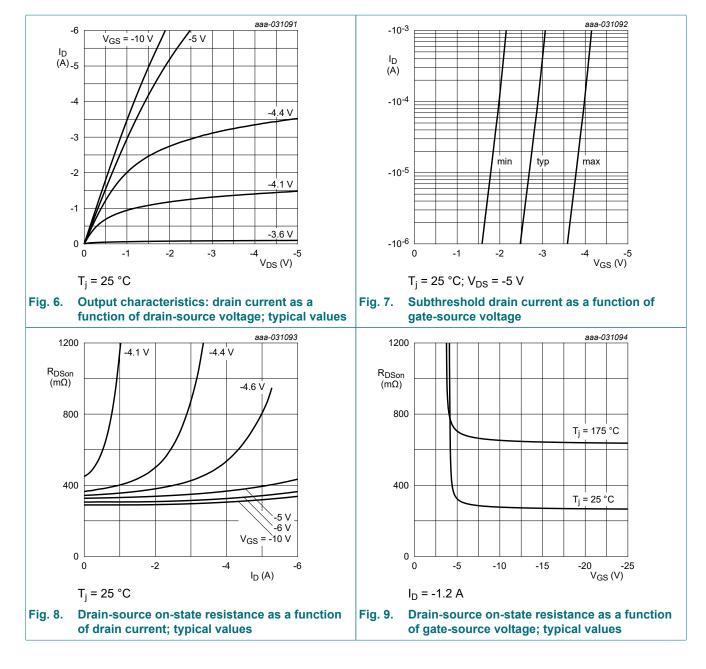
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.



### **10. Characteristics**

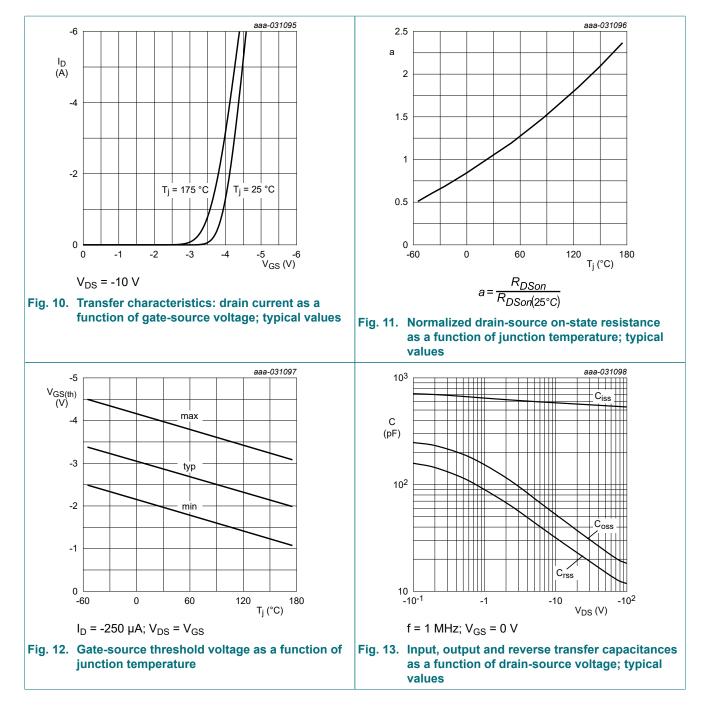
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	I <sub>D</sub> = -250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-100	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-2	-2.9	-4	V
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = -100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-1	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = -25 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-100	nA
		V <sub>GS</sub> = 25 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -1.2 A; T <sub>j</sub> = 25 °C	-	280	365	mΩ
resist	resistance	V <sub>GS</sub> = -10 V; I <sub>D</sub> = -1.2 A; T <sub>j</sub> = 175 °C	-	644	840	mΩ
		V <sub>GS</sub> = -6 V; I <sub>D</sub> = -1.1 A; T <sub>j</sub> = 25 °C	-	300	435	mΩ
9 <sub>fs</sub>	forward transconductance	V <sub>DS</sub> = -5 V; I <sub>D</sub> = -1.2 A; T <sub>j</sub> = 25 °C	-	4	-	S
R <sub>G</sub>	gate resistance	f = 1 MHz	-	11	-	Ω
Dynamic ch	aracteristics		I		_	
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = -50 V; I <sub>D</sub> = -1.4 A; V <sub>GS</sub> = -10 V;	-	10	15	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	2.1	-	nC
Q <sub>GD</sub>	gate-drain charge		-	2.6	-	nC
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = -50 V; f = 1 MHz; V <sub>GS</sub> = 0 V;	-	549	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	24	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	15	-	pF
t <sub>d(on)</sub>	turn-on delay time	V <sub>DS</sub> = -50 V; I <sub>D</sub> = -1.4 A; V <sub>GS</sub> = -10 V;	-	8	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	5	-	ns
t <sub>d(off)</sub>	turn-off delay time	1	-	23	-	ns
t <sub>f</sub>	fall time	1	-	22	-	ns
Source-drai	in diode	· · · · ·				
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -1.4 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-0.8	-1.2	V
t <sub>rr</sub>	reverse recovery time	I <sub>S</sub> = -1.4 A; dI <sub>S</sub> /dt = 100 A/µs;	-	28	-	ns
Q <sub>r</sub>	recovered charge	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = -40 V; T <sub>j</sub> = 25 °C	-	32	-	nC

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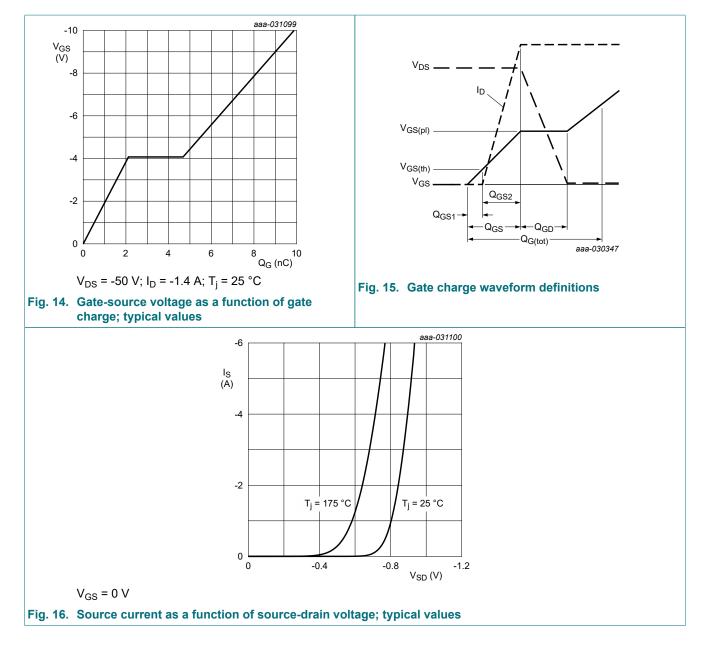
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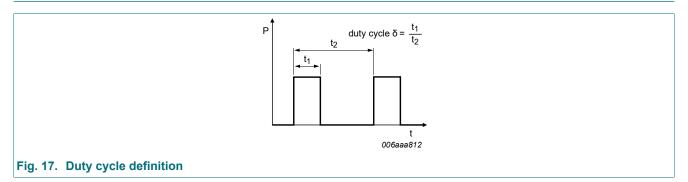


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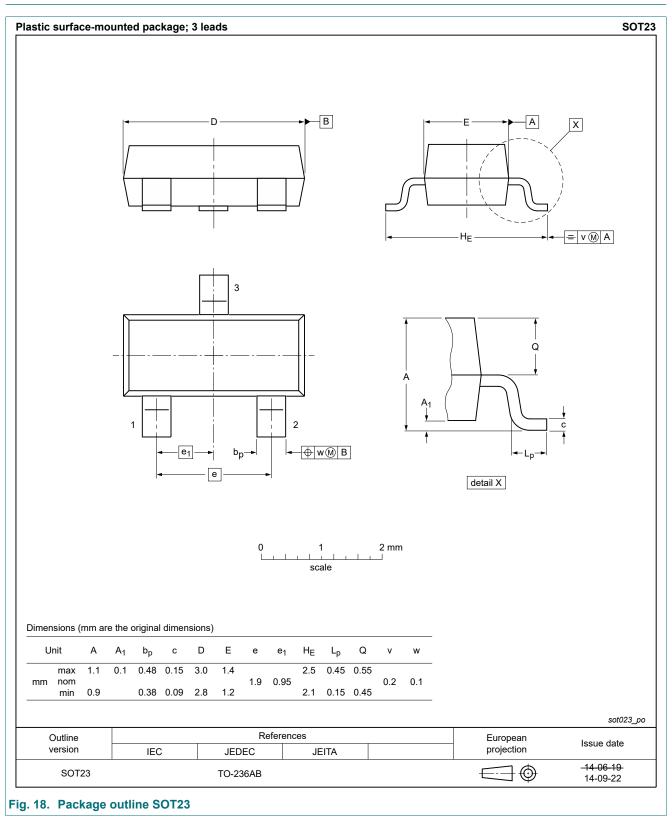
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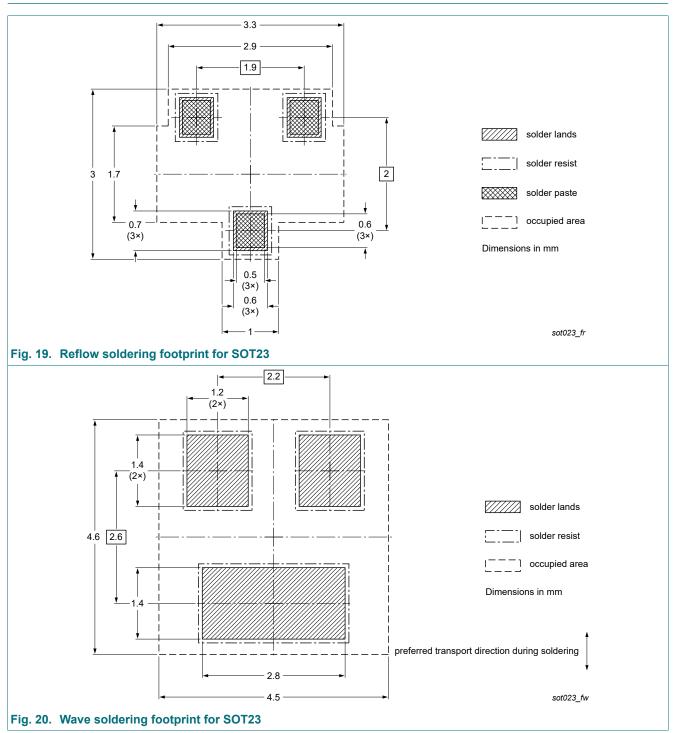
## **11. Test information**



#### 12. Package outline



### 13. Soldering



# 14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMV240SP v.1	20200825	Product data sheet	-	-		

## 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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